December 2001

FDR842P

FAIRCHILD SEMICONDUCTOR®

P-Channel 1.8V Specified PowerTrench[®] MOSFET

General Description

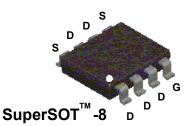
This P-Channel –1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

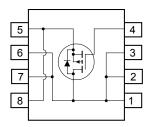
Applications

- Power management
- Load switch
- Battery protection

Features

- -11 A, -12 V $R_{DS(ON)}$ = 9 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 12 m Ω @ V_{GS} = -2.5 V $R_{DS(ON)}$ = 16 m Ω @ V_{GS} = -1.8 V
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		-12	V	
V _{GSS}	Gate-Source Voltage		± 8	V	
ID	Drain Current – Continuous	(Note 1a)	–11	A	
	– Pulsed		-50		
P _D	Power Dissipation for Single Operation	(Note 1a)	1.8	W	
		(Note 1b)	1.0		
		(Note 1c)	0.9		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		–55 to +150	°C	

Thermal Characteristics

R _{eJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	70	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	20	°C/W

Package Marking and Ordering Information

FDR842P FDR842P 13" 12mm 2500 units	Device Marking	Device	Reel Size	Tape width	Quantity
	FDR842P	FDR842P		12mm	2500 units

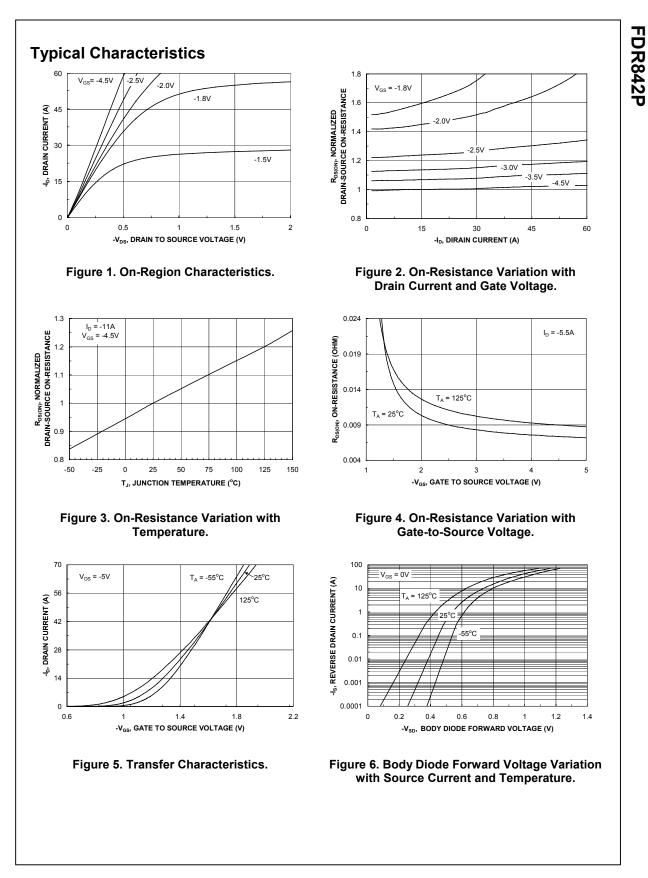
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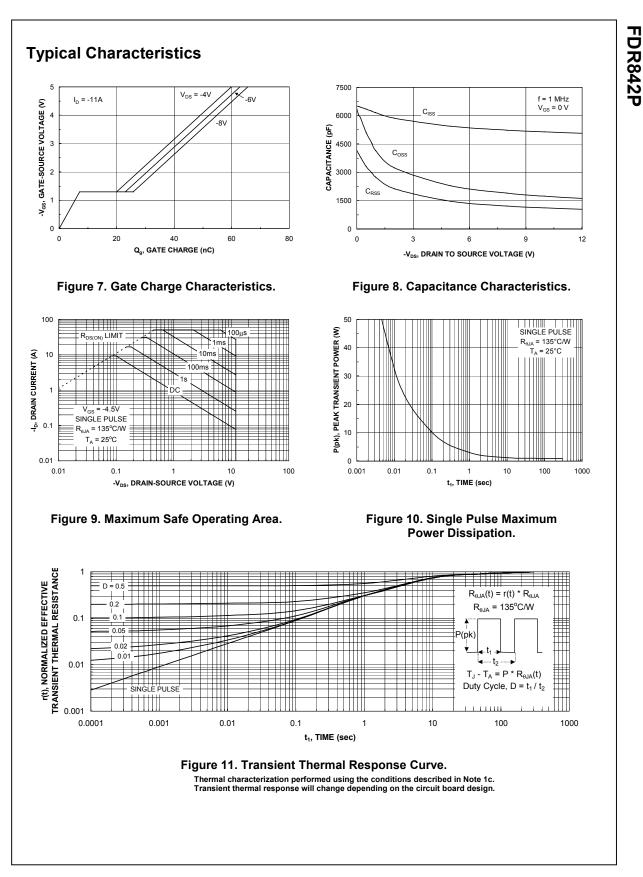
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	<u></u>				
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-12			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = –250 µA, Referenced to 25°C		-4.4		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -10 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
	Gate–Body Leakage, Reverse	$V_{GS} = -8 V, \qquad V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-0.5	-1.5	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = –250 µA, Referenced to 25°C		2.7		mV/°C
R _{DS(on)}	Static Drain-Source	$V_{GS} = -4.5 \text{ V}, I_D = -11 \text{ A}$		7	9	mΩ
	On–Resistance	$V_{GS} = -2.5 V$, $I_D = -9.5 A$		9	12	
		$V_{GS} = -1.8 V$, $I_D = -7.5 A$ $V_{GS} = -4.5 V$, $I_D = -11 A$, $T_J = 125^{\circ}C$		12 9	16 12	
I _{D(on)}	On–State Drain Current	$V_{GS} = -4.5 V, N_{DS} = -5 V$	-50			А
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -11 A$		56		S
-	Characteristics			-		<u> </u>
	Input Capacitance	$V_{DS} = -6 V$, $V_{GS} = 0 V$,		5350		pF
	Output Capacitance	$V_{DS} = -6 V$, $V_{GS} = 0 V$, f = 1.0 MHz		2135		pF
C _{rss}	Reverse Transfer Capacitance			1386		pF
				<u> </u>		
	g Characteristics (Note 2) Turn–On Delay Time	$V_{DD} = -6 V, I_D = -1 A,$		17	30	ns
t _r	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		20	35	ns
t _{d(off)}	Turn–Off Delay Time	•		201	322	ns
t _f	Turn–Off Fall Time	•		161	258	ns
Q _g	Total Gate Charge	$V_{DS} = -6 V$, $I_D = -11 A$,		57	80	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -4.5 V$		7		nC
Q _{gd}	Gate–Drain Charge	1		16		nC
-	ource Diode Characteristics	and Maximum Ratings		<u>. </u>		
l _s	Maximum Continuous Drain–Source				-1.5	А
	Drain–Source Diode Forward	$V_{GS} = 0 V$, $I_S = -1.5 A$ (Note 2)		-0.6	-1.2	V
V _{SD}	Voltage	$V_{GS} = 0 V$, $I_{S} = -1.5 R$ (Note 2)		-0.0	-1.2	v

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

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